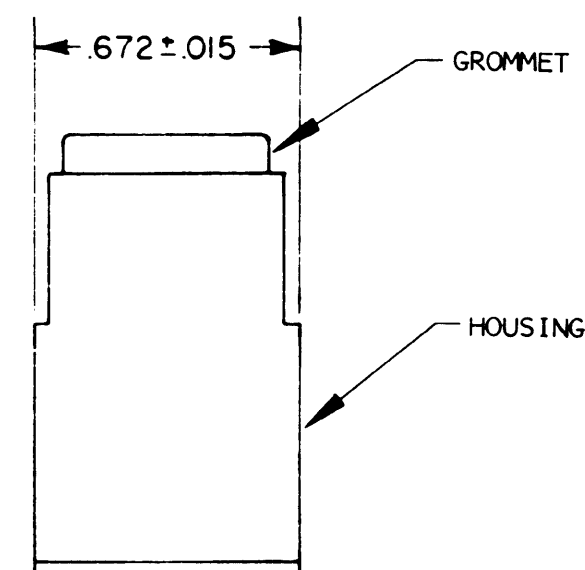
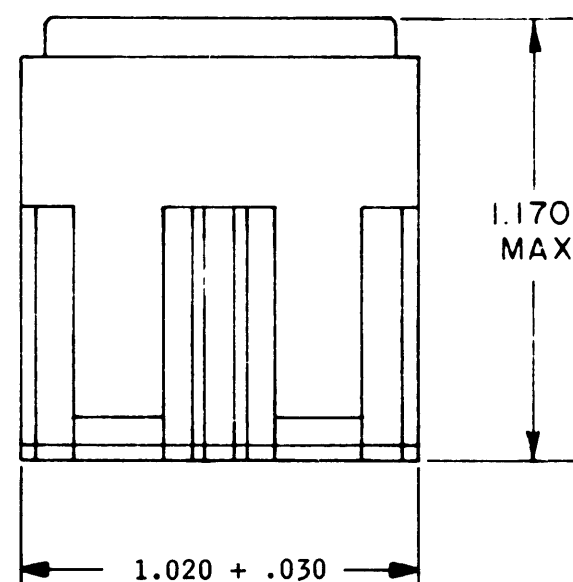
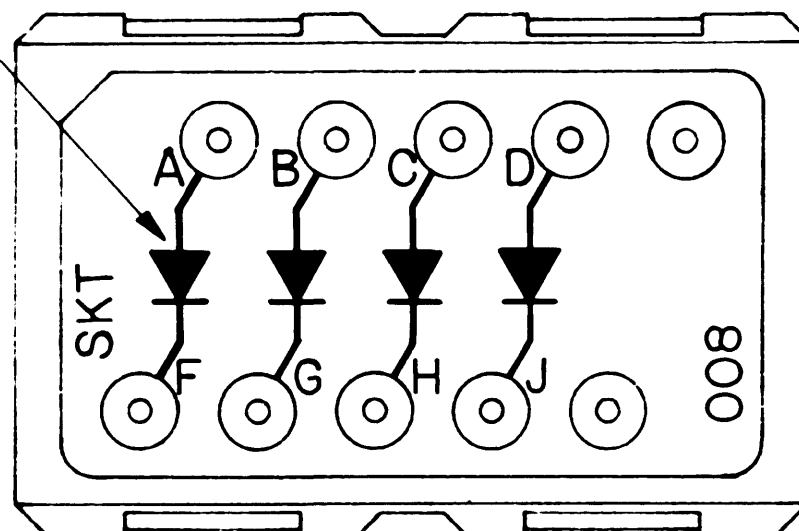


D CTJ420E008

REVISIONS			
SYM	DESCRIPTION	DATE	APPROVED
N/C	NEW RELEASE PER E.O. 82788	2-24-77	JDM
A	REVISED PER E.O. 82929	3-10-77	JDM
B	REVISED PER E.O. 89017	3-20-80	L. Stoll
C	REVISED PER E.O. A0962	12-2-83	L. Stoll
D	REVISED PER E.O. A 0976	2-22-84	J. Thomas

1000ES
SEE NOTE 7



8. TEMPERATURE RANGE: -67°F TO + 257°F
(-55°C TO +125°C)
7. MATERIALS & FINISHES:
HOUSINGS - THERMOPLASTIC
GROMMET - METHYL-VINYL SILICONE ELASTOMER
PIN CONTACTS - COPPER ALLOY PLATED GOLD
ELECTRONIC COMPONENTS - FOUR JANIX 1N3613 DIODES
6. REQUIRES CONTACT TOOL NO. MI5570-20.
5. SEE ENVELOPE DRAWING NO. CTJ-3*-** FOR SUITABLE RAIL ASSYS.
4. FOR CONTACT DATA SEE ENVELOPE DRAWING CTJ500.
3. CTJ420E008

CIRCUIT ARRANGEMENT.

NOTE:

2. THE CIRCUIT IDENTIFICATION WILL BE SCREENED ON MODULE.
1. DIMENSIONS ARE IN INCHES, UNLESS OTHERWISE SPECIFIED.

SIGNATURE & DATE	
DR	R. Wolcott 2-23-77
CHK	L. Stoll
PE	J. MAC DONALD 2-24-77
APPD	
SCALE	NONE
WT	

MODULE ASSEMBLY,
ELECTRONIC COMPONENT
SIZE 12
SIZE 20 CONTACTS
-008 ARRANGEMENT
ENVELOPE

CP	MATL CODE 16
The Deutsch Company ELECTRONIC COMPONENTS DIVISION Municipal Airport Banning, California	
B	CTJ420E008
DWG SIZE	CODE 11139
SHEET	1 OF 1